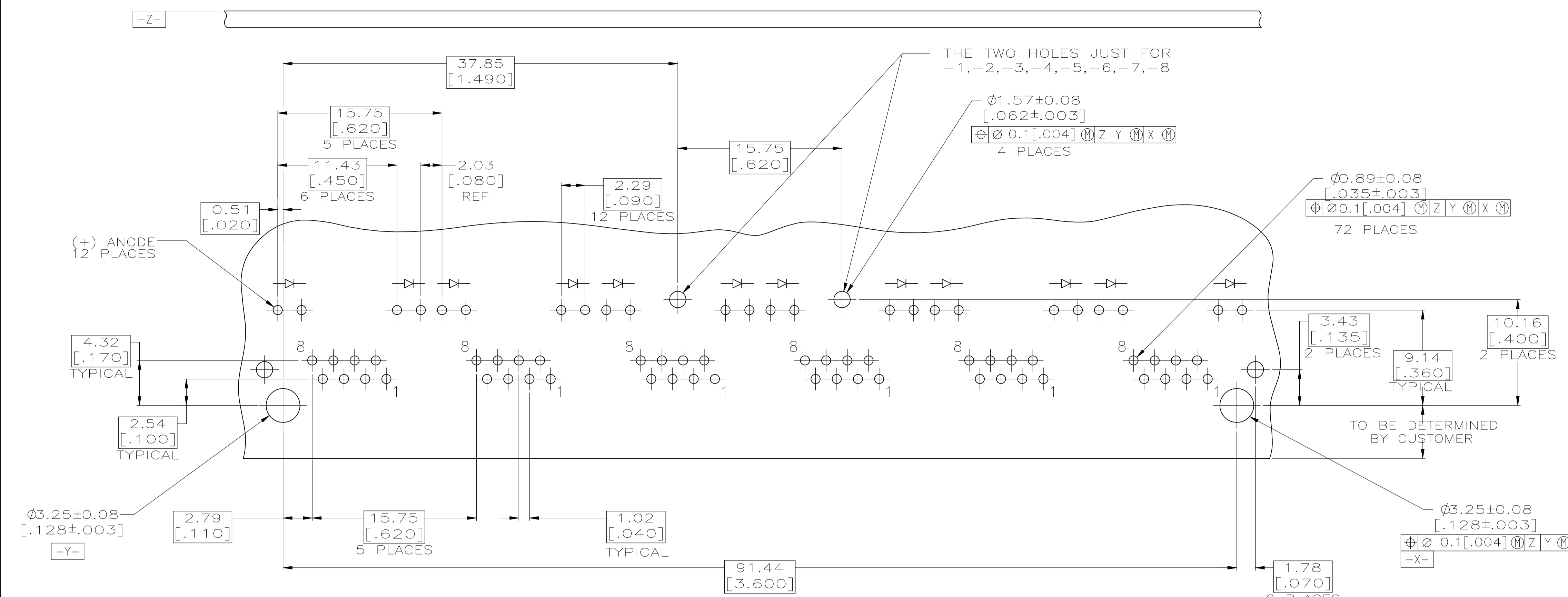


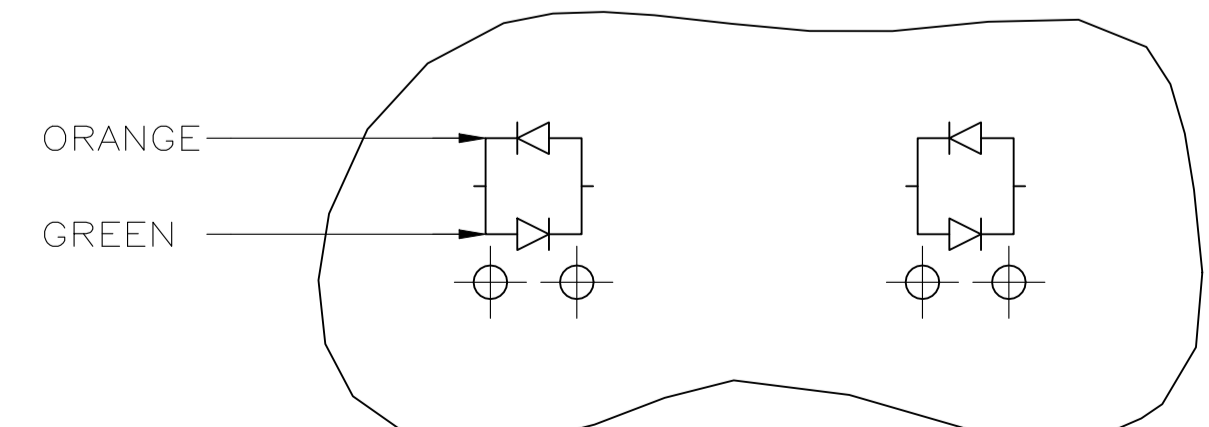
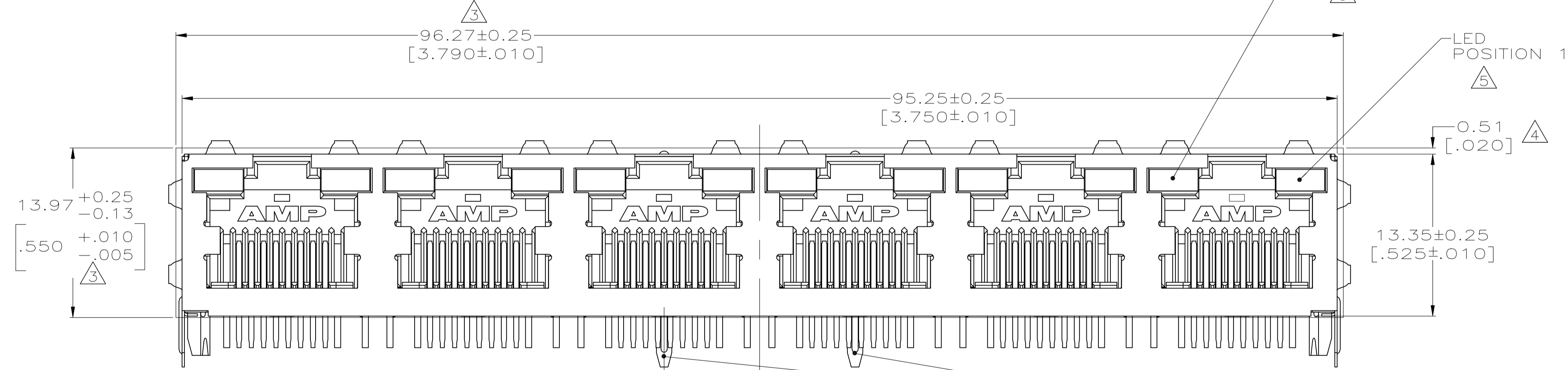
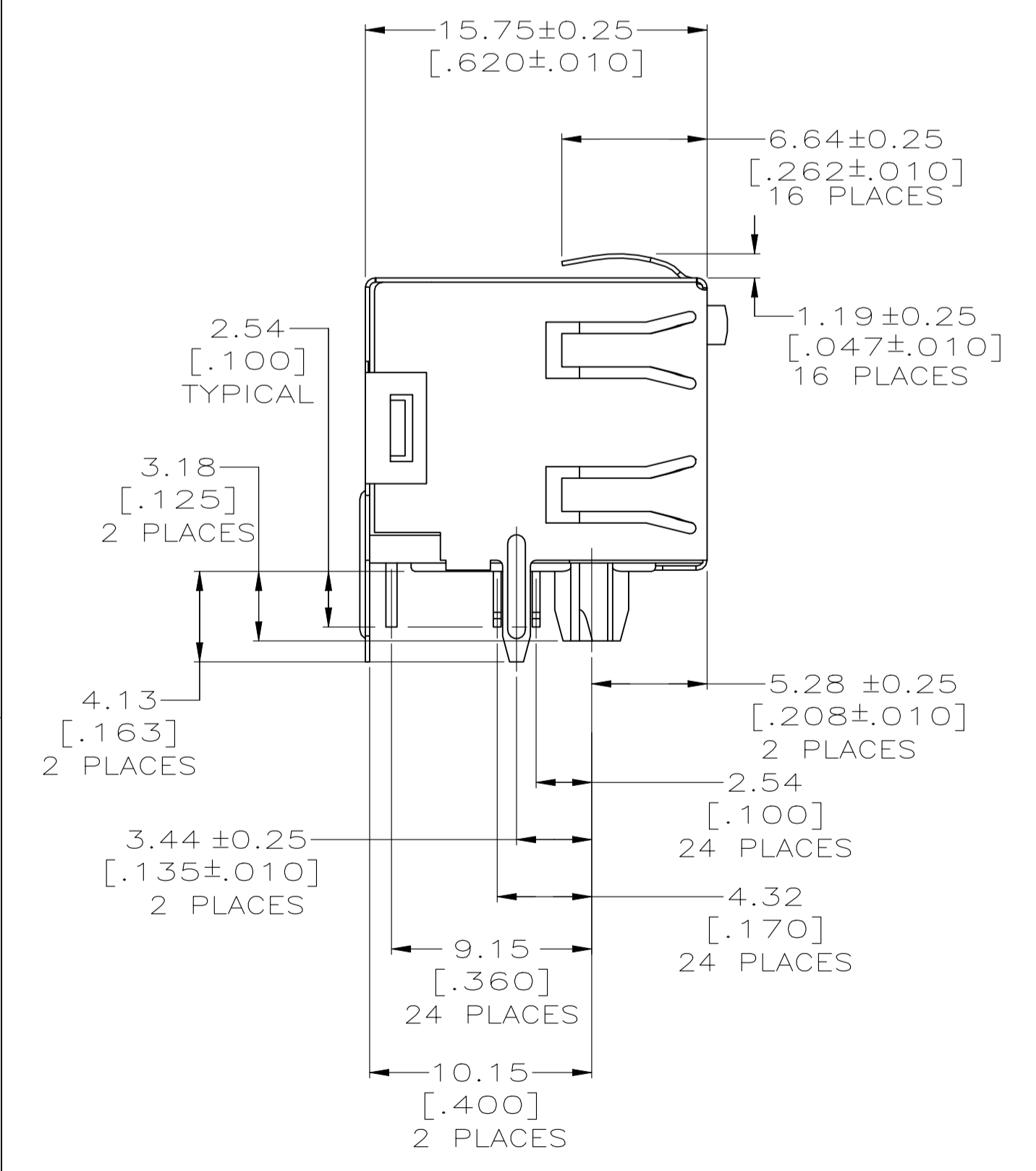
REVISIONS				
REV	DATE	BY	APP'D	DESCRIPTION
C1	25MAR2021	AK	SZ	REVISED PER ECO-21-003828



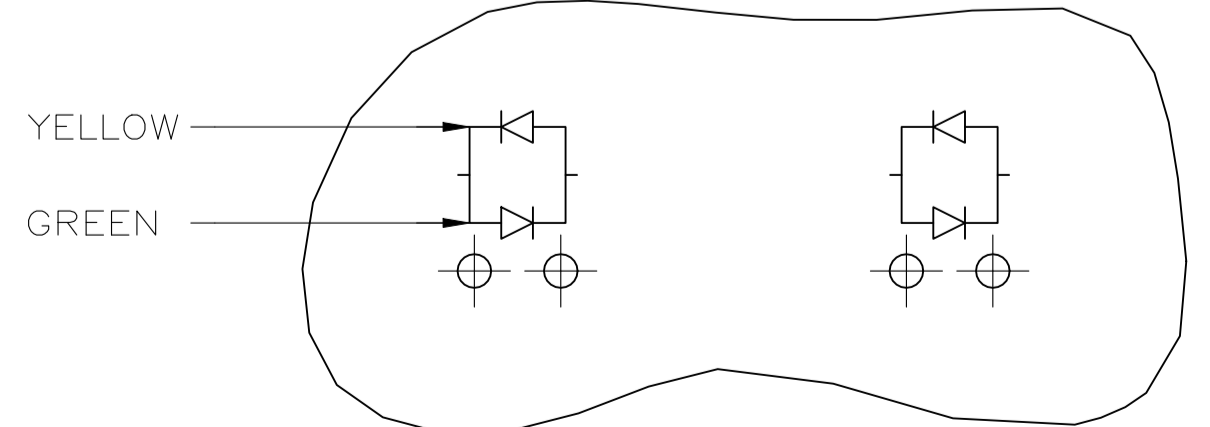
SUGGESTED PRINTED CIRCUIT BOARD LAYOUT (COMPONENT SIDE)

- MATERIAL:**
 HOUSING - HIGH TEMPERATURE THERMOPLASTIC, BLACK, UL94V-0.
 TERMINALS - 0.36[.014] THICK PHOS BRONZE PLATED WITH 3.81μm[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA. 1.27μm[.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27μm[.000050] MINIMUM THICK NICKEL.
 SHIELD - 0.196[.0077] THICK COPPER ZINC ALLOY PREPLATED WITH 1.27μm[.000050] MINIMUM SATIN NICKEL WITH 2.03μm[.000080] MINIMUM TIN POST DIPPED ON PCB GROUND TABS.
 LIGHT EMITTING DIODE (LED) - DIFFUSED EPOXY LENS, 0.51 x 0.51[.020 x .020] CARBON STEEL WIREFRAME LEADS PREPLATED WITH 8.89 μm[.0003500] THICK Sn/Cu OVER 2.03 μm[.000080] THICK Ag OVER 1.02μm[.000040] THICK Cu OVER 3.56 μm[.000140] THICK Ni OVER 1.02μm[.000040] Cu UNDERPLATE
- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
 - SUGGESTED PANEL OPENING DIMENSIONS.
 - SUGGESTED CLEARANCE BETWEEN TOP OF CONNECTOR AND TOP PANEL OPENING.
 - SEE TABLE FOR COLOR OF LEDS AND NUMBER REQUIRED.
 - THIS MODULAR JACK WITH INTEGRATED LED IS NOT IR REFLOW SOLDERING PROCESS COMPATIBLE.
 - FOR 5406554-9, NO REAR GROND TAB.
 - OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI

OBSOLETE



LED CURRENT DIAGRAM 5406554-7 ONLY



LED CURRENT DIAGRAM 5406554-8 ONLY

INDICATOR COLOR FOR EACH HOUSING	POSITION 2	POSITION 1	PART NUMBER
OBVIOUS	GREEN/YELLOW	GREEN/YELLOW	5406554-9
OBVIOUS	GREEN/YELLOW	GREEN/YELLOW	5406554-8
OBVIOUS	ORANGE/GREEN	ORANGE/GREEN	5406554-7
OBVIOUS	YELLOW	YELLOW	5406554-6
OBVIOUS	GREEN	GREEN	5406554-5
OBVIOUS	GREEN	YELLOW	5406554-4
OBVIOUS	YELLOW	-	5406554-3
OBVIOUS	-	GREEN	5406554-2

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: mm [INCHES]	TOLERANCES UNLESS OTHERWISE SPECIFIED:	DIN J. ALCORTA - 16JUN2005	DOCKS: J. WESTMAN - 16JUN2005
0. PLC ± -	1. PLC ± -	APVD S. FLICKINGER - 16JUN2005	NAME
2. PLC ± 0.25(.01)	3. PLC ± 0.13(.005)	PRODUCT SPEC	108-1163-4
4. PLC ± -	ANGLES ± -	APPLICATION SPEC	114-2154
MATERIAL	FINISH	WEIGHT	SIZE
			A1 00779
		C=5406554	RESTRICTED TO
		CUSTOMER DRAWING	SCALE 4:1 SHEET 1 of 1 REV C1

STE TE Connectivity
 INVERTED MODULAR JACK ASSEMBLY, 1X6, SHIELDED, PANEL GROUND, LED

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)